ASSP Mobile Communication Systems

SAW Filter (700 to 1000 MHz)

F5CM Series (B2)

DESCRIPTION

The F5CM series of SAW filters have balanced in/unbalanced out or unbalanced in/balanced out of I/O ports. Therefore these filters are suitable for the design using balanced type of IC. By using these filters, any transforming devises, such as balun is not required.

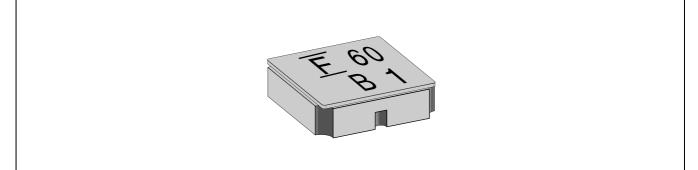
The F5CM series filters apply to the frequency range 700 to 1000MHz. High performance has been realized with high reliability and small size by using original materials and original design.

The F5CM series filters are suitable for RF interstage filter in mobile communication systems and standard parts are available for GSM and AMPS/TDMA/CDMA standards.

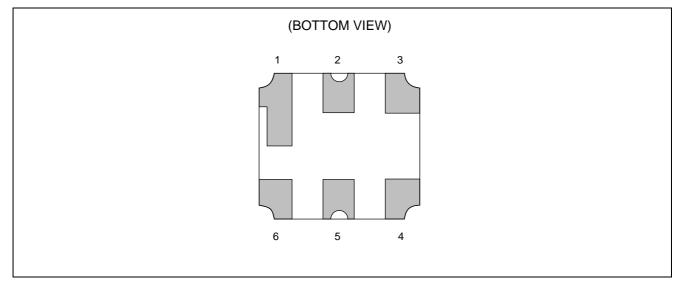
FEATURES

- Balanced/unbalanced I/O ports
- Ultra compact and light package (3.0 mm × 3.0 mm package)
- · Any external matching network is not required
- Excellent stopband attenuation
- Small inband ripple
- Surface mount package (SMT)

PACKAGE



■ PIN ASSIGNMENT



PIN DESCRIPTION

BALANCED IN/UNBALANCED OUT type (Tx filter)

Pin no.	Pin name	Description
1	GND	Ground Pin
2	OUT	Unbalanced output
3	GND	Ground Pin
4	IN	Balanced Input
5	GND	Ground Pin
6	IN	Balanced Input

UNBALANCED IN/BALANCED OUT type (Rx filter)

Pin no.	Pin name	Description
1	GND	Ground Pin
2	IN	Unbalanced Input
3	GND	Ground Pin
4	OUT	Balanced Output
5	GND	Ground Pin
6	OUT	Balanced Output

Parameter	Symbol	Ra	ting	Unit	
Farameter	Symbol	Min.	Max.	Onit	
Operating temperature	Та	-30	+85	٥C	
Storage temperature	Tstg	-40	+100	°C	
Input power	Pin	—	+15	dBm	
Input DC Voltage	DCin	-5	+5	V	

WARNING: Piezoelectric devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Va	Unit	
Falameter	Symbol	Min.	Onit	
Operating temperature	Та	-30	+85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the piezoelectric device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use piezoelectric devices within their recommended operating conditionranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

STANDARD FREQUENCIES

Applicat	ions	Frequency (MHz)	Band width (MHz)	Input type/ Impedance	Output type/ Impedance	Part number	Part symbol
	Тх	902.5	25	Balance 50 Ω	Unbalance50 Ω	FAR-F5CM-902M50-B263	63
GSM	Rx	947.5	25	Unbalance	Balance50 Ω	FAR-F5CM-947M50-B260	60
	ΓX		25	50 Ω	Balance150 Ω	FAR-F5CM-947M50-B262	62
EGSM	Rx	942.5	35	Unbalance 50 Ω	Balance50 Ω	FAR-F5CM-942M50-B270	70
AMPS/ TDMA/	Тх	836.5	25	Balance 50 Ω	Unbalance50 Ω	FAR-F5CM-836M50-B268	68
CDMA	Rx	881.5	25	Unbalance 50 Ω	Balance50 Ω	FAR-F5CM-881M50-B266	66

ELECTRICAL CHARACTERISTICS

1. GSM (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-902M50-B263

						$(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$
Parameter	Conditions		Value		Unit	Remarks
Falameter	Conditions	Min.	Тур.	Max.	Unit	Remarks
Insertion loss	890 to 915 MHz		3.2	3.5	dB	
Inband ripple	890 to 915 MHz	_	1.2	1.5	dB	
	DC to 845 MHz	45	58	—	dB	
	845 to 870 MHz	25	50	_	dB	
Absolute attenuation	935 to 980 MHz	25	30	—	dB	
	980 to 2000 MHz	40	58	—	dB	
	2000 to 3000 MHz	30	37	—	dB	

2. GSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-947M50-B260

						$(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$
Parameter	Conditions		Value		Unit	Remarks
Falameter	conditions	Min.	Тур.	Max.	Onic	Nemarks
Insertion loss	935 to 960 MHz	—	3.0	3.3	dB	
Inband ripple	935 to 960 MHz	—	0.9	1.2	dB	
	DC to 890 MHz	45	56		dB	
	890 to 915 MHz	25	31	_	dB	
Absolute attenuation	980 to 1025 MHz	25	30	_	dB	
	1025 to 2000 MHz	40	50	_	dB	
	2000 to 3000 MHz	35	45		dB	

3. GSM (Rx) 50 ohms Unbalanced IN/150 ohms Balanced OUT Part number: FAR-F5CM-947M50-B262

						$(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$
Parameter	Conditions		Value		Unit	Remarks
Farameter	Conditions	Min.	Тур.	Max.	Onic	itemarks
Insertion loss	935 to 960 MHz	_	3.3	3.8	dB	
Inband ripple	935 to 960 MHz	_	0.8	1.3	dB	
	DC to 890 MHz	45	55	_	dB	
	890 to 915 MHz	25	48		dB	
Absolute attenuation	980 to 1025 MHz	23	29	—	dB	
	1025 to 2000 MHz	40	50	—	dB	
	2000 to 3000 MHz	35	39		dB	

4. EGSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-942M50-B270

 $(Ta = -30^{\circ}C to + 85^{\circ}C)$

Parameter	Conditions		Value		Unit	Remarks
Falameter	conditions	Min.	Тур.	Max.	Onic	itemarks
Insertion loss	925 to 960 MHz	—	3.8	4.5	dB	
Inband ripple	925 to 960 MHz		1.8	2.5	dB	
	DC to 880 MHz	50	55		dB	
	880 to 915 MHz	15	22	_	dB	
Absolute attenuation	980 to 1025 MHz	23	27	—	dB	
	1025 to 2000 MHz	40	44		dB	
	2000 to 3000 MHz	25	39		dB	

5. AMPS/TDMA/CDMA (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-836M50-B268

 $(Ta = -30^{\circ}C to + 85^{\circ}C)$

Parameter	Conditions		Value		Unit	Remarks
Falameter	Conditions	Min.	Тур.	Max.	Unit	Reillarks
Insertion loss	824 to 849 MHz		2.8	3.5	dB	
Inband ripple	824 to 849 MHz		0.9	1.6	dB	
	DC to 800 MHz	45	52		dB	
Absolute	869 to 920 MHz	25	33	_	dB	
attenuation	920 to 2000 MHz	35	46	—	dB	
	2000 to 3000 MHz	25	33		dB	

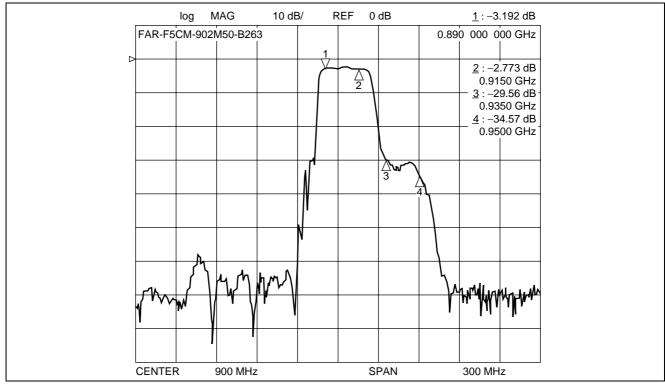
6. AMPS/TDMA/CDMA (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-881M50-B266

 $(Ta = -30^{\circ}C \text{ to } + 85^{\circ}C)$

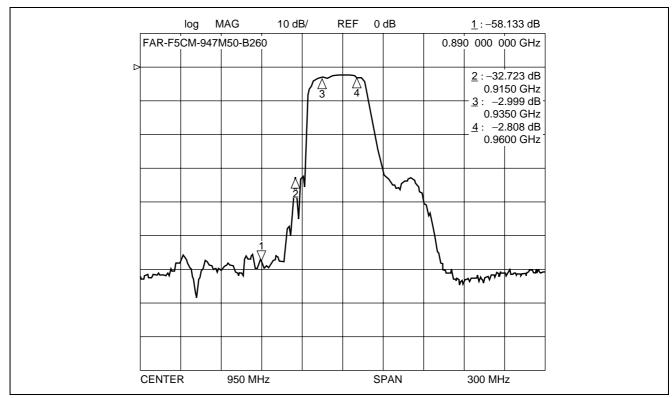
Parameter	Conditions	Value			11:0:14	Demerice
Farameter	Conditions	Min.	Тур.	Max.	Unit	Remarks
Insertion loss	869 to 894 MHz		2.8	3.5	dB	
Inband ripple	869 to 894 MHz		0.8	1.5	dB	
	DC to 800 MHz	45	55		dB	
	800 to 849 MHz	30	47		dB	
Absolute attenuation	940 to 1000 MHz	30	38	_	dB	
	1000 to 2000 MHz	35	47	—	dB	
	2000 to 3000 MHz	25	32		dB	

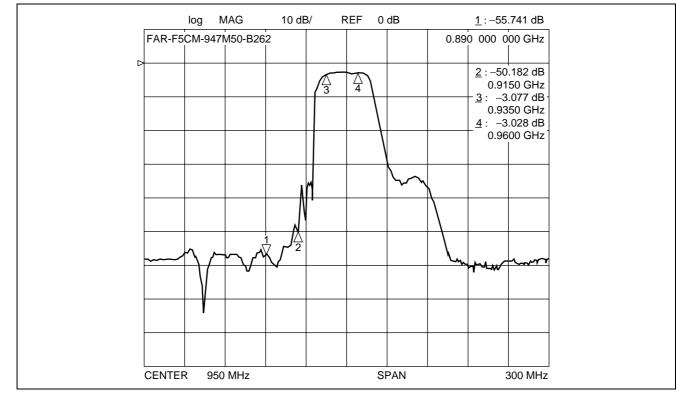
■ TYPICAL CHARACTERISTICS

1. GSM (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-902M50-B263



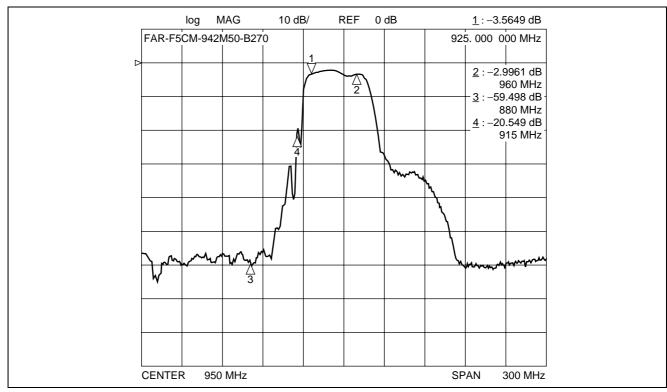
2. GSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-947M50-B260

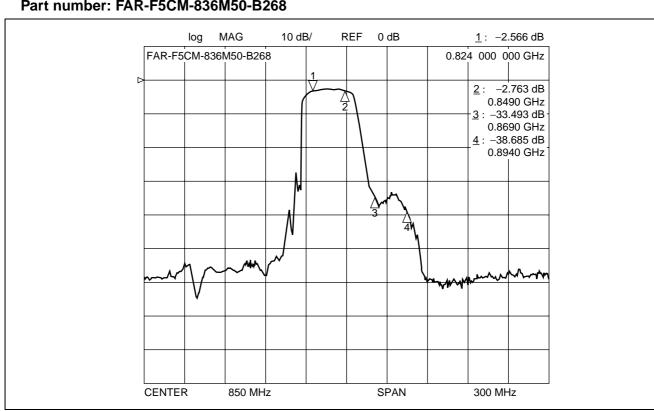




3. GSM (Rx) 50 ohms Unbalanced IN/150 ohms Balanced OUT Part number: FAR-F5CM-947M50-B262

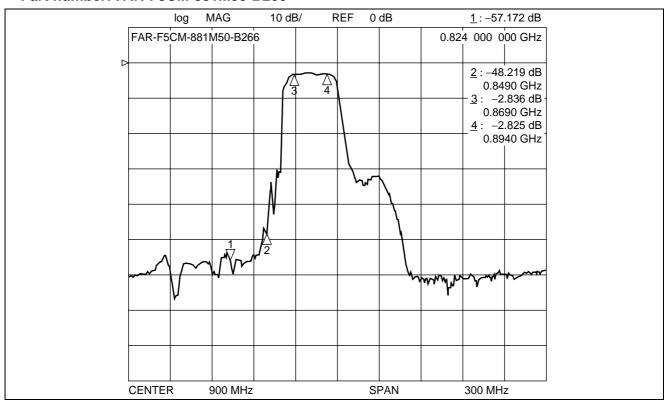
4. EGSM (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-942M50-B270



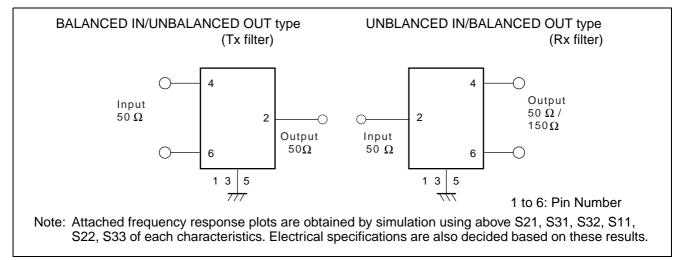


5. AMSP/TDMA/CDMA (Tx) 50 ohms Balanced IN/50 ohms Unbalanced OUT Part number: FAR-F5CM-836M50-B268

6. AMSP/TDMA/CDMA (Rx) 50 ohms Unbalanced IN/50 ohms Balanced OUT Part number: FAR-F5CM-881M50-B266



MEASURMENT CIRCUIT

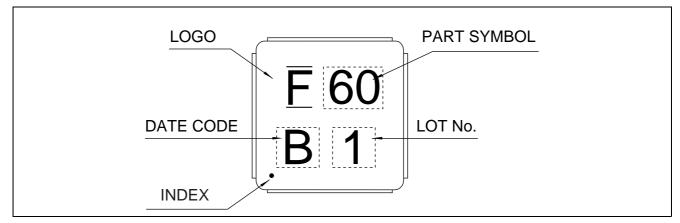


PART NUMBER DESIGNATION

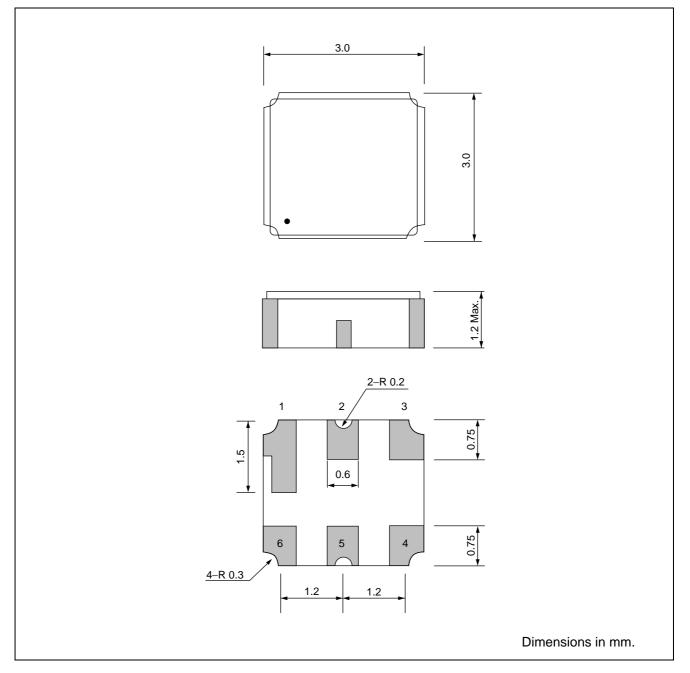
[Designation example]

(1) Frequency: Center frequency is specified in six alphanumeric. Enter M (for MHz) at the decimal point. Refer to below example. [Example] 902.5 MHz \Rightarrow 902M50 (2) Part symbol: Specified characters from 60 to 79. (3) Packing: W: 1000 pcs/reel (Reeled tape) V: 3000 pcs/reel U: 5000 pcs/reel

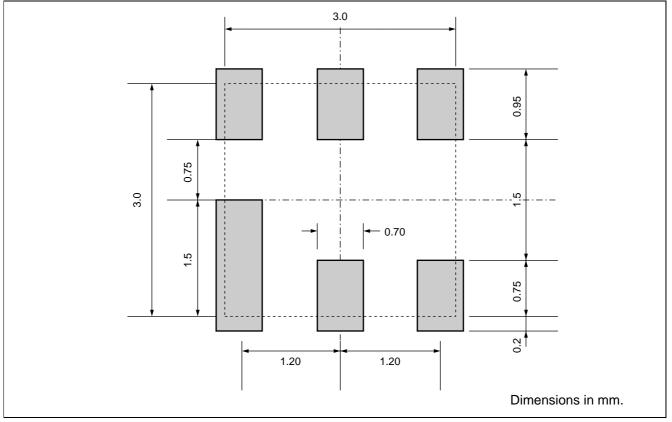
MARKING



■ PACKAGE DIMENSION

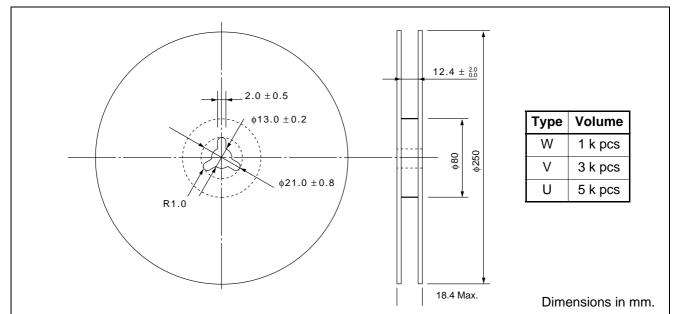


■ RECOMMENDED LAND PATTERN

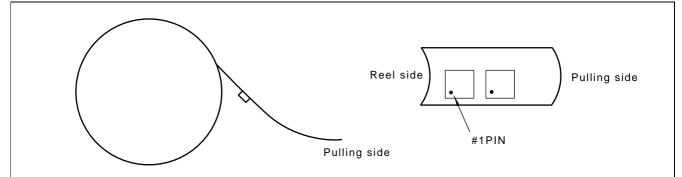


■ PACKING: Reel type

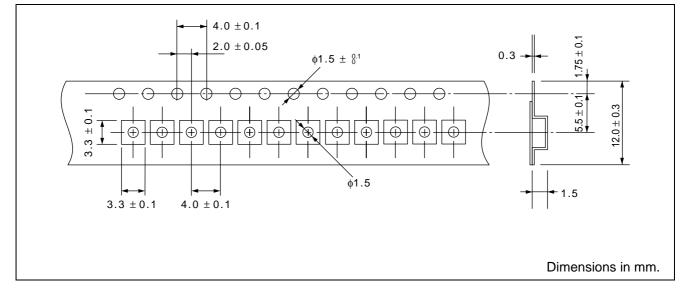
1. Reel Dimensions



2. Packing Style

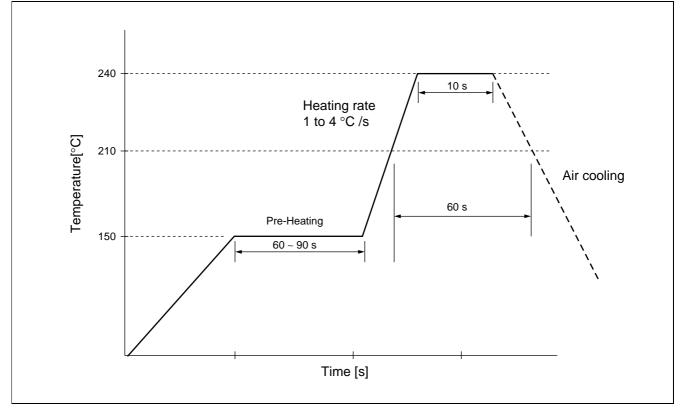


3. Tape Dimensions



4. Peel Strength of Top Cover Tape Peel off by the force of 0.1 N to 0.7 N under the condition at the right. Direction of pulling (Conforms to JIS C 0806 section 5.2) Direction of pulling 165 to 180 ° Embossment carrier type tape

■ RECOMMENDED REFLOW PROFILE



■ NOTE

Mass-produced product order is accepted by a unit of 1000.

FUJITSU MEDIA DEVICES LIMITED

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